

Standard Metal Film Leaded Resistors

-(2111)-------

FEATURES

- · Low cost
- Low noise (max. 1.5 μ V/V for R > 1 M Ω)
- Small size (SFR16S: 0204, SFR25/25H: 0207)



- Lead (Pb)-free solder contacts
- Pure tin plating provides compatibility with lead (Pb)-free and lead containing soldering processes
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

• General purpose resistors

A homogeneous film of metal alloy is deposited on a high grade ceramic body. After a helical groove has been cut in the resistive layer, tinned connecting leads of electrolytic copper are welded to the end-caps.

The resistors are coated with a colored lacquer (light-blue for type SFR16S; light-green for type SFR25 and red-brown for type SFR25H) which provides electrical, mechanical and climatic protection. The encapsulation is resistant to all cleaning solvents in accordance with IEC 60068-2-45.

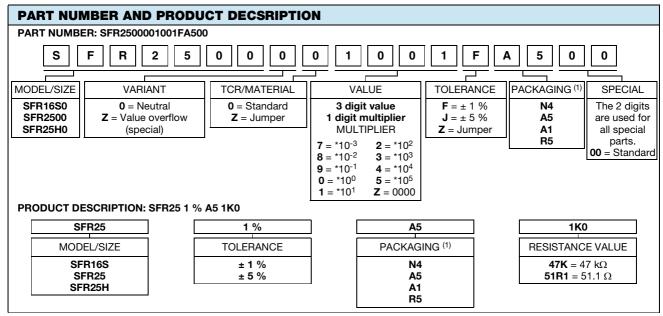
TECHNICAL SPECIFICATIONS				
DESCRIPTION	UNIT	SFR16S	SFR25	SFR25H
		± 5 %; 1 to 3M	± 5 %; 0.5	22 to 10M
Resistance Range	Ω	\pm 1 %; 4.99 to 3M	± 1 %;	I to 10M
		Jumper (0 Ω)	Jumper (0 Ω)	
Resistance Tolerance	%	± 1,	E24/E96 series; ± 5, E24 se	eries
Temperature Coefficient:				
$R \le 4.7 \Omega$		\leq \pm 250	≤ ± 100	≤ ± 100
$4.7 \Omega < R \le 100 \text{ k}\Omega$	ppm/K	≤ ± 100	≤ ± 100	≤± 100
100 k Ω < R ≤ 1 M Ω		≤ ± 250	≤ ± 100	≤ ± 100
$R > 1 \text{ M}\Omega$		\leq \pm 250	≤ ± 250	≤ ± 250
Rated Dissipation, P ₇₀	W	0.5	0.4	0.5
Thermal Resistance, R _{th}	K/W	170	200	150
Maximum Permissible Voltage, (U _{max.} AC/DC)	V	200	250	350
Noise:				
$R < 68 \text{ k}\Omega$		max. 0.1	max. 0.1	max. 0.1
68 kΩ ≤ R ≤ 100 kΩ	μV/V	max. 0.5	max. 0.1	max. 0.1
100 kΩ $\leq R \leq$ 1 MΩ		max. 1.5	max. 0.1	max. 0.1
$R > 1 \text{ M}\Omega$		max. 1.5	max. 1.5	max. 1.5
Basic Specifications			IEC 60115-1	
Climatic Category (IEC 60068-1)			55/155/56	
Stability, ΔR max., after:				
Load (1000 h, P ₇₀):				
R Range		\pm (2 % R + 0.05 Ω)	\pm (2 % R + 0.05 Ω)	\pm (2 % R + 0.05 Ω)
Long Term Damp Heat Test (56 Days):				
$R \le 1 M\Omega$		\pm (1 % R + 0.05 Ω)	\pm (1 % R + 0.05 Ω)	\pm (1 % R + 0.05 Ω)
$R > 1 \text{ M}\Omega$		\pm (1 % R + 0.05 Ω)	\pm (1 % R + 0.05 Ω)	± (2 % R + 0.1 Ω)
Soldering (10 s, 260 °C)		± (0.25 % R + 0.05 Ω)	± (0.25 % R + 0.05 Ω)	± (0.25 % R + 0.05 Ω)
Short Time Overload		± (0.25 % R + 0.05 Ω)	± (0.25 % R + 0.05 Ω)	± (1 % R + 0.05 Ω)

Note

• R value is measured with probe distance of 24 mm ± 1 mm using 4-terminal method

Revision: 05-Mar-13 Document Number: 28722





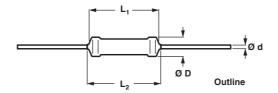
Notes

(1) Please refer to table PACKAGING

- The jumper has a maximum resistance $R_{\text{max.}} = 30 \text{ m}\Omega$ at 3 A (SFR16S)
- The jumper has a maximum resistance $R_{\rm max.}$ = 30 m Ω at 5 A (SFR25)
- The PART NUMBER is shown to facilitate the introduction of a unified part numbering system for ordering products

PACKAGING								
MODEL	TOLEDANIOE	TAPING	AMMO PACK		RE	EL		
MODEL	TOLERANCE		PIECES	CODE	PIECES	CODE		
SFR16S	1 %	Axial, 52 mm	5000	A5	5000	R5		
0ED400	5 %	Axial, 52 mm	5000	A5	5000	R5		
SFR16S			1000	A1		กอ		
SFR25, SFR25H	1 %	Axial, 52 mm	5000	A5	5000	R5		
SFR25, SFR25H	5 %	Axial, 52 mm	5000	A5	5000	R5		
SFR25, SFR25H	5 %	Axiai, 52 IIIIII	1000	A1	3000	нэ		
SFR25, SFR25H	1 %	Radial	4000	N4	-	-		
SFR25, SFR25H	5 %	Radial	4000	N4	-	-		

DIMENSIONS



DIMENSIONS - Resistor types and relevant physical dimensions in millimeters						
TYPE	Ø D _{max.}	L _{1 max.}	L _{2 max.}	Ød		
SFR16S	1.9	3.5	4.1	0.45 ± 0.05		
SFR25	2.5	6.5	7.5	0.58 ± 0.05		
SFR25H	2.5	6.5	7.5	0.58 ± 0.05		

Revision: 05-Mar-13 2 Document Number: 28722



MASS PER UNIT				
TYPE	MASS (mg)			
SFR16S	102			
SFR25	205			
SFR25H	205			

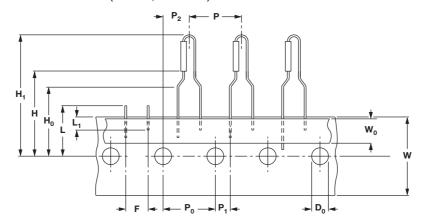
OUTLINES

The length of the body (L_1) is measured by inserting the leads into holes of two identical gauge plates and moving these plates parallel to each other until the resistor body is clamped without deformation (IEC 60294).

MARKING

The nominal resistance and tolerance are marked on the resistor using four or five colored bands in accordance with IEC 60062, marking codes for resistors and capacitors.

PRODUCTS WITH RADIAL LEADS (SFR25, SFR25H)



DIMENSIO	DIMENSIONS - Radial taping						
SYMBOL	PARAMETER	VALUE	TOLERANCE	UNIT			
Р	Pitch of components	12.7	± 1.0	mm			
P ₀	Feed-hole pitch	12.7	± 0.2	mm			
P ₁	Feed-hole centre to lead at topside at the tape	3.85	± 0.5	mm			
P ₂	Feed-hole center to body center	6.35	± 1.0	mm			
F	Lead-to-lead distance	4.8	+ 0.7/- 0	mm			
W	Tape width	18.0	± 0.5-	mm			
W ₀	Minimum hold down tape width	5.5	-	mm			
H1	Component height	29	Max.	mm			
H ₀	Lead wire clinch height	16.5	± 0.5	mm			
H ₀	Height of component from tape center	19.5	± 1	mm			
D ₀	Feed-hole diameter	4.0	± 0.2	mm			
L	Maximum length of snipped lead	11.0	-	mm			
L ₁	Minimum lead wire (tape portion) shortest lead	2.5	-	mm			

Note

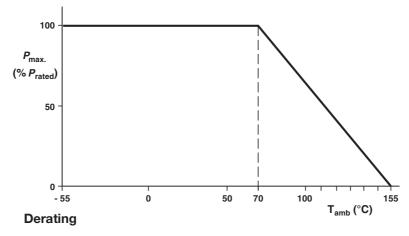
• Please refer to document "Packaging" for more detail (www.vishay.com/doc?28721).



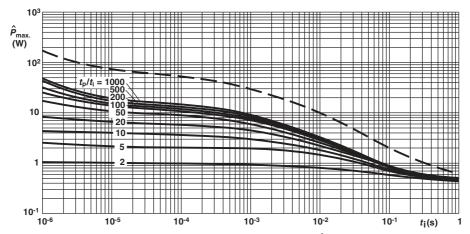
FUNCTIONAL PERFORMANCE PRODUCT CHARACTERIZATION

Standard values of nominal resistance are taken from the E96/E24 series for resistors with a tolerance of \pm 1 % or \pm 5 %. The values of the E96/E24 series are in accordance with IEC 60063.

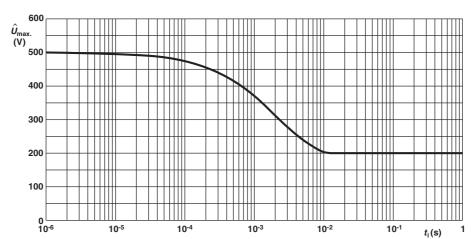
The power that the resistor can dissipate depends on the operating temperature



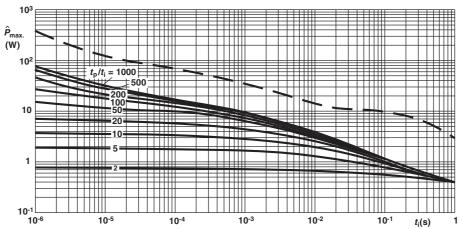
Maximum dissipation (P_{max.}) in percentage of rated power as a function of the ambient temperature (T_{amb})



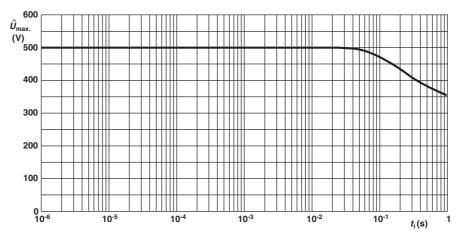
SFR16S Pulse on a regular basis; maximum permissible peak pulse power (\hat{P}_{max}) as a function of pulse duration (t_i)



SFR16S Pulse on a regular basis; maximum permissible peak pulse voltage (\hat{U}_{max}) as a function of pulse duration (t_i)

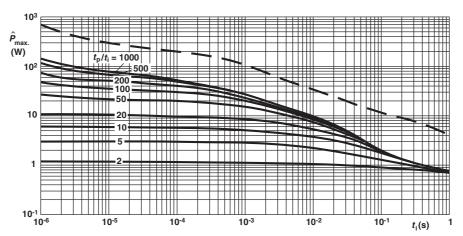


SFR25 Pulse on a regular basis; maximum permissible peak pulse power (\hat{P}_{max}) as a function of pulse duration (t_i)



SFR25 Pulse on a regular basis; maximum permissible peak pulse voltage (\hat{U}_{max}) as a function of pulse duration (t_i)

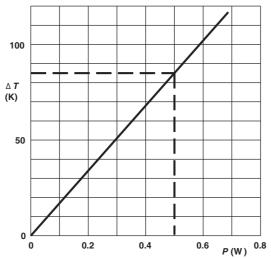




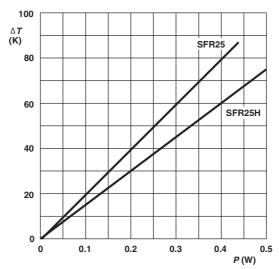
SFR25H Pulse on a regular basis; maximum permissible peak pulse power (\hat{P}_{max}) as a function of pulse duration (t_i)



SFR25H Pulse on a regular basis; maximum permissible peak pulse voltage (\hat{U}_{max}) as a function of pulse duration (t_i)



SFR16S Hot-spot temperature rise (ΔT) as a function of dissipated power



SFR25/SFR25H Hot-spot temperature rise (ΔT) as a function of dissipated power

Note

• The maximum permissible hot-spot temperature is 155 °C.

Application Information



TESTS AND REQUIREMENTS

Essentially all tests are carried out in accordance with IEC 60115-1 specification, category LCT/UCT/56 (rated temperature range: Lower Category Temperature, Upper Category temperature; damp heat, steady state, test duration: 56 days).

The tests are carried out in accordance with IEC 60068-2-xx test method under standard atmospheric conditions according to IEC 60068-1, 5.3.

In the Test Procedures and Requirements table, tests and requirements are listed with reference to the relevant clauses of IEC 60115-1 and IEC 60068-2-xx test methods. A short description of the test procedure is also given. In some instances deviations from the IEC recommendations were necessary for our method of specifying. All soldering tests are performed with mildly activated flux.

IEC 60115-1	IEC 60068-2	TEOT	PROCESURE	RESISTANCE		REQUIREMENTS	6
CLAUSE	TEST METHOD	TEST	PROCEDURE	RANGE	SFR16S	SFR25	SFR25H
4.16		Robustness of terminations:					
4.16.2	21 (Ua1)	Tensile all samples	Ø 0.45 mm, load 5 N; 10 s Ø 0.58 mm, load 10 N; 10 s		Number of failures < 10 x 10 ⁻⁶		x 10 ⁻⁶
4.16.3	21 (Ub)	Bending half number of samples	Ø 0.45 mm, load 2.5 N; 4 x 90° Ø 0.58 mm, load 5 N; 4 x 90°		Number of failures < 10 x 10 ⁻⁶		
4.16.4	21 (Uc)	Torsion other half of samples	3 x 360° in opposite directions		ΔR ma	No damage x.: ± (0.25 % R +	0.05 Ω)
4.17	20 (Ta)	Solderability	2 s; 235 °C: Solder bath method; SnPb40 3 s; 245 °C: Solder bath method; SnAg3Cu0.5		Good tinning (≥ 95 % covered) no damage		overed);
		Solderability (after aging)	8 h steam or 16 h 155 °C; leads immersed 6 mm; for 2 s at 235 °C: Solder bath (SnPb40) for 3 s at 245 °C: Solder bath (SnAgCu0.5) method		Good	tinning (≥ 95 % cc no damage	overed);
4.18 20 (Tb) Resistance to soldering heat			Thermal shock: 10 s; 260 °C; 3 mm from body		∆R ma	x.: ± (0.25 % R +	0.05 Ω)
4.19	14 (Na)	Rapid change of temperature	30 min at - 55 °C and 30 min at + 155 °C; 5 cycles		∆R ma	x.: ± (0.25 % R +	0.05 Ω)
4.20	29 (Eb)	Bump	3 x 1500 bumps in 3 directions; 40 g		∆R ma	No damage x.: ± (0.25 % R +	0.05 Ω)
4.22	6 (Fc)	Vibration	Frequency 10 Hz to 500 Hz; displacement 1.5 mm or acceleration 10 g; 3 directions; total 6 h (3 x 2 h)		ΔR ma	No damage x.: ± (0.25 % <i>R</i> +	0.05 Ω)
4.23	0.75	Climatic sequence:	401 :			R _{ins} min.: 1000 Mg	Ω
4.23.2	2 (Ba)	Dry heat Damp heat	16 h; 155 °C				
4.23.3	30 (Db)	(accelerated) 1 st cycle	24 h; 55 °C; 90 % to 100 % RH				
4.23.4	1 (Aa)	Cold	2 h; - 55 °C				
4.23.5	13 (M)	Low air pressure	2 h; 8.5 kPa; 15 °C to 35 °C				
		Damp heat	5 days; 55 °C;	<i>R</i> ≤ 1 MΩ	∆R m	nax.: ± (1 % R + 0	.05 Ω) ΔR max.
4.23.6	30 (Db)	(accelerated) remaining cycles	95 % to 100 % RH	R > 1 MΩ	ΔR max.: ± (1	$\%~R+0.05~\Omega)$	± (2 % F + 0.1 Ω)



IEC	IEC 60068-2	068-2	DD005DUD5	RESISTANCE	REQUIREMENTS			
60115-1 CLAUSE	TEST METHOD	TEST	PROCEDURE	RANGE	SFR16S	SFR25	SFR25H	
4.24	78 (Cab)	Damp heat (steady state)	56 days; 40 °C; 90 % to 95 % RH; loaded with 0.01 P ₇₀ (steps: 0 V to 100 V)		$R_{\rm ins}$ min.: 1000 MΩ Δ R max.: ± (2 % R + 0.05 Ω)			
4.25.1		Endurance (at 70 °C)	1000 h; loaded with P_{70} or $U_{\rm max.}$; 1.5 h ON and 0.5 h OFF		ΔR m	ax.: ± (2 % R + 0	.05 Ω)	
4.8		Temperature coefficient	Between - 55 °C and + 155 °C	$R < 4.7 \Omega$ $R \le 100 \text{ k}\Omega$ $R \le 1 \text{ M}\Omega$ $R > 1 \text{ M}\Omega$	≤ ± 250 ppm/K ≤ ± 100 ppm/K ≤ ± 250 ppm/K ≤ ± 250 ppm/K	≤ ± 100 ppm/K ≤ ± 100 ppm/K ≤ ± 100 ppm/K ≤ ± 250 ppm/K	≤ ± 100 ppm/l ≤ ± 100 ppm/l ≤ ± 100 ppm/l ≤ ± 250 ppm/l	
4.7		Voltage proof on insulation	$U_{\rm RMS} = 400$ V (SFR16S) or $U_{\rm RMS} = 600$ V (SFR25 and SFR25H); during 1 min; V-block method		No breakdown			
4.12		Noise	IEC 60195	$R < 68 \text{ k}\Omega$ $R \le 100 \text{ k}\Omega$ $R \le 1 \text{ M}\Omega$ $R > 1 \text{ M}\Omega$	max. 0.1 μV/V max. 0.5 μV/V max. 1.5 μV/V max. 1.5 μV/V	max. 0.1 μV/V max. 0.1 μV/V max. 0.1 μV/V max. 1.5 μV/V	max. 0.1 μV/\ max. 0.1 μV/\ max. 0.1 μV/\ max. 1.5 μV/\	
4.6.1.1		Insulation resistance	U _{max.} DC = 500 V during 1 min; V-block method		R_{ins} min.: 1000 M Ω			
/ 1·3		Short time overload	Room temperature; $P = 6.25 \times P_n$ (SFR25, SFR25H) or $6.25 \times 0.25 \text{ W (SFR16S)};$ (voltage not more than $2 \times \text{limiting voltage});$ 10 cycles; 5 s ON and 45 s OFF			nax.: R + 0.05 Ω)	ΔR max.: ± 1 % R + 0.05 Ω)	

HISTORICAL 12NC INFORMATION

- The resistors had a 12-digit numeric code starting with 23.
- The subsequent 6 digits for 1 % or 7 digits for 5 % indicated the resistor type and packaging.
- The remaining digits indicated the resistance value:
 - The first 3 digits for 1 % or 2 digits for 5 % indicated the resistance value.
 - The last digit indicated the resistance decade.

Resistance Decade for ± 5 % Tolerance

RESISTANCE DECADE	LAST DIGIT
0.10 Ω to 0.91 Ω	7
1 Ω to 9.1 Ω	8
10 Ω ο 91 Ω	9
100 Ω to 910 Ω	1
1 kΩ to 9.1 kΩ	2
10 kΩ to 91 kΩ	3
100 kΩ to 910 kΩ	4
1 MΩ to 9.1 MΩ	5
= 10 MΩ	6

Resistance Decade for ± 1 % Tolerance

RESISTANCE DECADE	LAST DIGIT
1 Ω to 9.76 Ω	8
10 Ω to 97.6 Ω	9
100 Ω to 976 Ω	1
1 kΩ to 9.76 kΩ	2
10 kΩ to 97.6 kΩ	3
100 k Ω to 976 k Ω	4
1 MΩ to 9.76 MΩ	5
= 10 MΩ	6

12NC Example

The 12NC of a SFR25 resistor, value 5600 Ω ± 5 %, taped on a bandolier of 5000 units in ammopack was: 2322 181 43562.



HISTORICAL 12NC - Resistor type and packaging							
		23					
TYPE	TOL.	BANDOLIER IN AMMOPACK			BANDOLIER ON REEL		
		RADIAL TAPED	STRAIGH	IT LEADS	STRAIGHT LEADS		
		4000 UNITS	1000 UNITS	5000 UNITS	5000 UNITS		
	± 5 %	-	22 187 73	22 187 53	06 187 23		
SFR16S	± 1 %	-	-	06 187 3	06 187 1		
	Jumper	-	-	06 187 90013	22 187 90346		
	± 5 %	06 184 03	22 181 53	22 181 43	22 181 63		
SFR25	± 1 %	-	-	22 188 2	06 181 8		
	Jumper	-	22 181 90018	22 181 90019	06 181 90011		
SFR25H	± 5 %	06 186 03	22 186 16	22 186 76	06 186 63		
SFR25H	± 1 %	-	-	22 186 3	06 186 8		

Legal Disclaimer Notice



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

Material Category Policy

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as RoHS-Compliant fulfill the definitions and restrictions defined under Directive 2011/65/EU of The European Parliament and of the Council of June 8, 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment (EEE) - recast, unless otherwise specified as non-compliant.

Please note that some Vishay documentation may still make reference to RoHS Directive 2002/95/EC. We confirm that all the products identified as being compliant to Directive 2002/95/EC conform to Directive 2011/65/EU.

Vishay Intertechnology, Inc. hereby certifies that all its products that are identified as Halogen-Free follow Halogen-Free requirements as per JEDEC JS709A standards. Please note that some Vishay documentation may still make reference to the IEC 61249-2-21 definition. We confirm that all the products identified as being compliant to IEC 61249-2-21 conform to JEDEC JS709A standards.

Revision: 02-Oct-12 Document Number: 91000